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### [Understanding Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	69
Number of Gates	6000
Voltage - Supply	3V ~ 3.6V, 4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	100-BQFP
Supplier Device Package	100-PQFP (20x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/a40mx04-3pq100">https://www.e-xfl.com/product-detail/microchip-technology/a40mx04-3pq100</a>

Figure 51	BG272 .....	145
Figure 52	PG132 .....	153
Figure 53	CQ172 .....	158

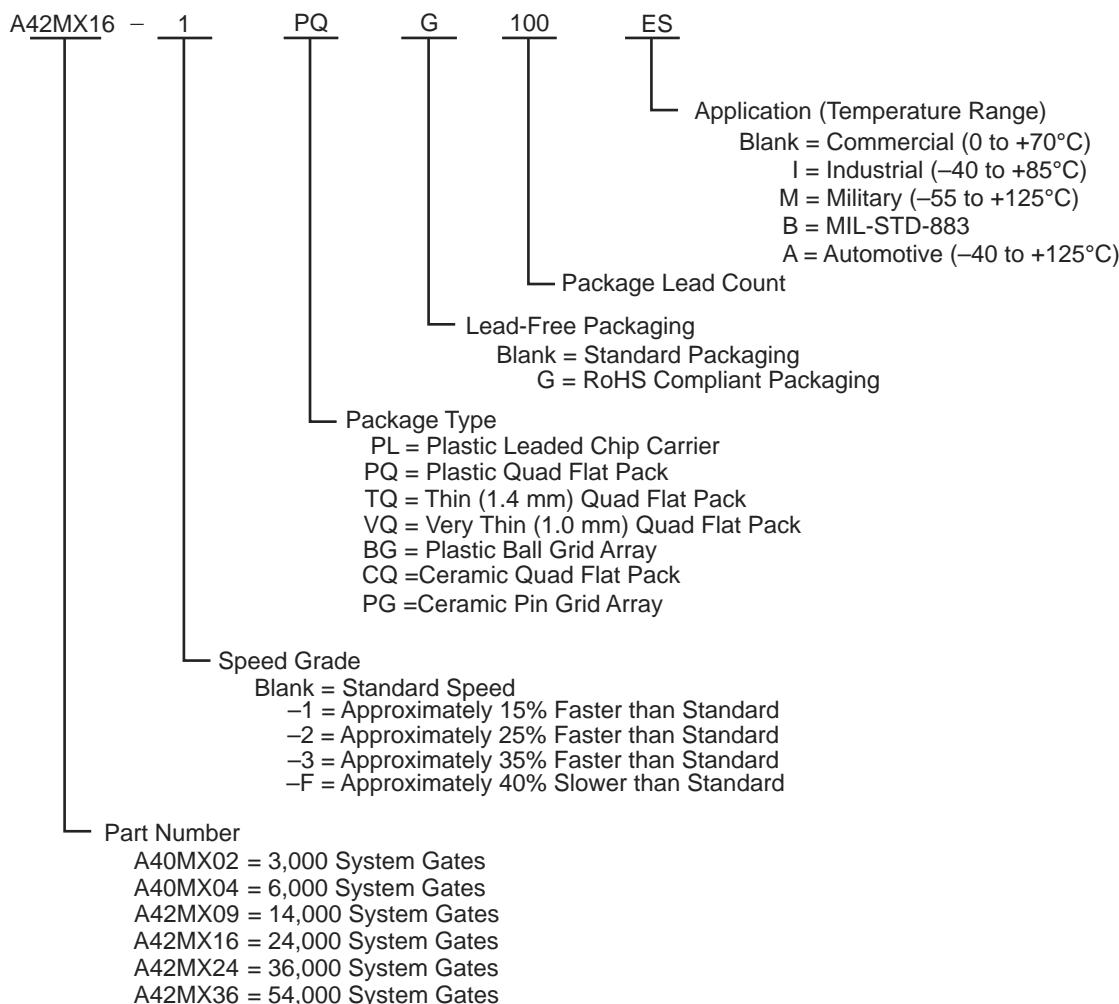
**Table 1 • Product profile**

<b>Device</b>	<b>A40MX02</b>	<b>A40MX04</b>	<b>A42MX09</b>	<b>A42MX16</b>	<b>A42MX24</b>	<b>A42MX36</b>
<b>Maximum Flip-Flops</b>	147	273	516	928	1,410	1,822
<b>Clocks</b>	1	1	2	2	2	6
<b>User I/O (maximum)</b>	57	69	104	140	176	202
<b>PCI</b>	–	–	–	–	Yes	Yes
<b>Boundary Scan Test (BST)</b>	–	–	–	–	Yes	Yes
Packages (by pin count)						
PLCC	44, 68	44, 68, 84	84	84	84	–
PQFP	100	100	100, 144, 160	100, 160, 208	160, 208	208, 240
VQFP	80	80	100	100	–	–
TQFP	–	–	176	176	176	–
CQFP	–	–	–	172	–	208, 256
PBGA	–	–	–	–	–	272
CPGA	–	–	132	–	–	–

## 2.3 Ordering Information

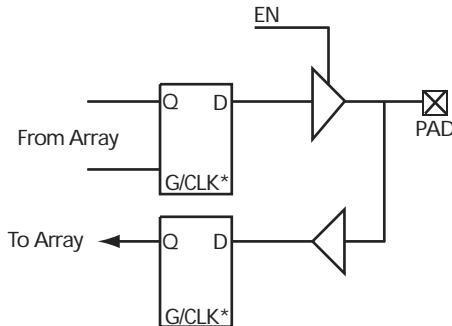
The following figure shows ordering information. All the following tables show plastic and ceramic device resources, temperature and speed grade offerings.

**Figure 1 • Ordering Information**



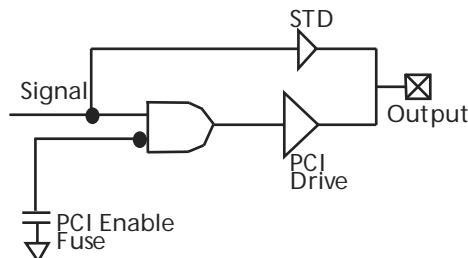
Designer software development tools provide a design library of I/O macro functions that can implement all I/O configurations supported by the MX FPGAs.

**Figure 10 • 42MX I/O Module**



**Note:** \*Can be configured as a Latch or D Flip-Flop (Using C-Module)

**Figure 11 • PCI Output Structure of A42MX24 and A42MX36 Devices**



### 3.3 Other Architectural Features

The following sections cover other architectural features of 40MX and 42MX FPGAs.

#### 3.3.1 Performance

MX devices can operate with internal clock frequencies of 250 MHz, enabling fast execution of complex logic functions. MX devices are live on power-up and do not require auxiliary configuration devices and thus are an optimal platform to integrate the functionality contained in multiple programmable logic devices. In addition, designs that previously would have required a gate array to meet performance can be integrated into an MX device with improvements in cost and time-to-market. Using timing-driven place-and-route (TDPR) tools, designers can achieve highly deterministic device performance.

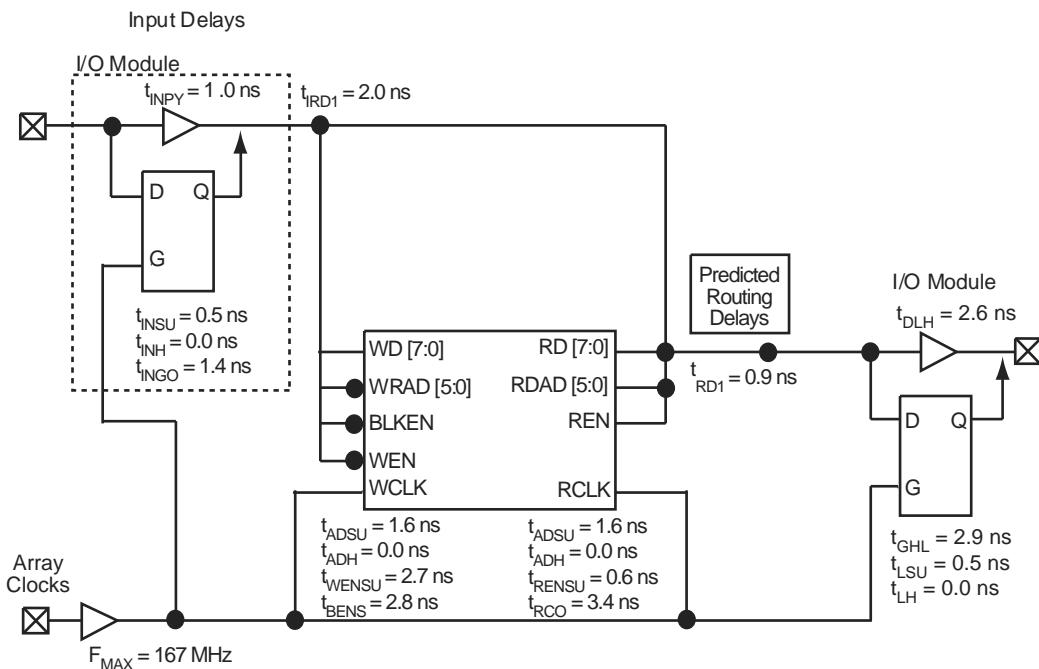
#### 3.3.2 User Security

Microsemi FuseLock provides robust security against design theft. Special security fuses are hidden in the fabric of the device and protect against unauthorized users attempting to access the programming and/or probe interfaces. It is virtually impossible to identify or bypass these fuses without damaging the device, making Microsemi antifuse FPGAs protected with the highest level of security available from both invasive and noninvasive attacks.

Special security fuses in 40MX devices include the Probe Fuse and Program Fuse. The former disables the probing circuitry while the latter prohibits further programming of all fuses, including the Probe Fuse. In 42MX devices, there is the Security Fuse which, when programmed, both disables the probing circuitry and prohibits further programming of the device.

#### 3.3.3 Programming

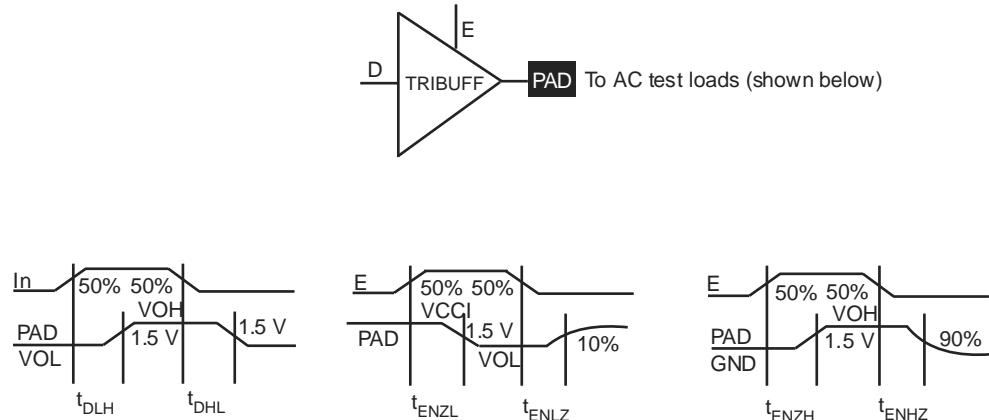
Device programming is supported through the Silicon Sculptor series of programmers. Silicon Sculptor is a compact, robust, single-site and multi-site device programmer for the PC. With standalone software, Silicon Sculptor is designed to allow concurrent programming of multiple units from the same PC.

**Figure 20 • 42MX Timing Model (SRAM Functions)**

**Note:** Values are shown for A42MX36 –3 at 5.0 V worst-case commercial conditions.

### 3.10.1 Parameter Measurement

The following figures show parameter measurement details.

**Figure 21 • Output Buffer Delays**

**Table 41 • A42MX16 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 3.0 V, TJ = 70°C)**

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Logic Module Sequential Timing<sup>3, 4</sup></b>											
t <sub>SUD</sub>	Flip-Flop (Latch) Data Input Set-Up	0.5	0.5	0.6	0.7	0.9					ns
t <sub>HD</sub>	Flip-Flop (Latch) Data Input Hold	0.0	0.0	0.0	0.0	0.0					ns
t <sub>SUENA</sub>	Flip-Flop (Latch) Enable Set-Up	1.0	1.1	1.2	1.4	2.0					ns
t <sub>HENA</sub>	Flip-Flop (Latch) Enable Hold	0.0	0.0	0.0	0.0	0.0					ns
t <sub>WCLKA</sub>	Flip-Flop (Latch) Clock Active Pulse Width	4.8	5.3	6.0	7.1	9.9					ns
t <sub>WASYN</sub>	Flip-Flop (Latch) Asynchronous Pulse Width	6.2	6.9	7.9	9.2	12.9					ns
t <sub>A</sub>	Flip-Flop Clock Input Period	9.5	10.6	12.0	14.1	19.8					ns
t <sub>IINH</sub>	Input Buffer Latch Hold	0.0	0.0	0.0	0.0	0.0					ns
t <sub>INSU</sub>	Input Buffer Latch Set-Up	0.7	0.8	0.9	1.01	1.4					ns
t <sub>OUTH</sub>	Output Buffer Latch Hold	0.0	0.0	0.0	0.0	0.0					ns
t <sub>OUTSU</sub>	Output Buffer Latch Set-Up	0.7	0.8	0.89	1.01	1.4					ns
f <sub>MAX</sub>	Flip-Flop (Latch) Clock Frequency	129	117	108	94	56	MHz				
<b>Input Module Propagation Delays</b>											
t <sub>IINYH</sub>	Pad-to-Y HIGH	1.5	1.6	1.9	2.2	3.1	ns				
t <sub>IINYL</sub>	Pad-to-Y LOW	1.1	1.3	1.4	1.7	2.4	ns				
t <sub>INGH</sub>	G to Y HIGH	2.0	2.2	2.5	2.9	4.1	ns				
t <sub>INGL</sub>	G to Y LOW	2.0	2.2	2.5	2.9	4.1	ns				
<b>Input Module Predicted Routing Delays<sup>2</sup></b>											
t <sub>IRD1</sub>	FO = 1 Routing Delay	2.6	2.9	3.2	3.8	5.3	ns				
t <sub>IRD2</sub>	FO = 2 Routing Delay	2.9	3.2	3.7	4.3	6.1	ns				
t <sub>IRD3</sub>	FO = 3 Routing Delay	3.3	3.6	4.1	4.9	6.8	ns				
t <sub>IRD4</sub>	FO = 4 Routing Delay	3.6	4.0	4.6	5.4	7.6	ns				
t <sub>IRD8</sub>	FO = 8 Routing Delay	5.1	5.6	6.4	7.5	10.5	ns				
<b>Global Clock Network</b>											
t <sub>CKH</sub>	Input LOW to HIGH	FO = 32	4.4	4.8	5.5	6.5	9.0	ns			
		FO = 384	4.8	5.3	6.0	7.1	9.9	ns			
t <sub>CKL</sub>	Input HIGH to LOW	FO = 32	5.3	5.9	6.7	7.8	11.0	ns			
		FO = 384	6.2	6.9	7.9	9.2	12.9	ns			
t <sub>PWH</sub>	Minimum Pulse Width HIGH	FO = 32	5.7	6.3	7.1	8.4	11.8	ns			
		FO = 384	6.6	7.4	8.3	9.8	13.7	ns			

**Table 41 • A42MX16 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 3.0 V, TJ = 70°C)**

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PWL</sub> Minimum Pulse Width LOW	FO = 32	5.3	5.9	6.7	7.8	11.0	ns				
	FO = 384	6.2	6.9	7.9	9.2	12.9	ns				
t <sub>CKSW</sub> Maximum Skew	FO = 32		0.5	0.5	0.6	0.7	1.0	ns			
	FO = 384		2.2	2.4	2.7	3.2	4.5	ns			
t <sub>SUEXT</sub> Input Latch External Set-Up	FO = 32	0.0	0.0	0.0	0.0	0.0	0.0	ns			
	FO = 384	0.0	0.0	0.0	0.0	0.0	0.0	ns			
t <sub>HEXT</sub> Input Latch External Hold	FO = 32	3.9	4.3	4.9	5.7	8.0	ns				
	FO = 384	4.5	4.9	5.6	6.6	9.2	ns				
t <sub>P</sub> Minimum Period	FO = 32	7.0	7.8	8.4	9.7	16.2	ns				
	FO = 384	7.7	8.6	9.3	10.7	17.8	ns				
f <sub>MAX</sub> Maximum Frequency	FO = 32		142	129	119	103	62	MHz			
	FO = 384		129	117	108	94	56	MHz			
<b>TTL Output Module Timing<sup>5</sup></b>											
t <sub>DLH</sub> Data-to-Pad HIGH			3.5	3.9	4.4	5.2	7.3	ns			
t <sub>DHL</sub> Data-to-Pad LOW			4.1	4.6	5.2	6.1	8.6	ns			
t <sub>ENZH</sub> Enable Pad Z to HIGH			3.8	4.2	4.8	5.6	7.8	ns			
t <sub>ENZL</sub> Enable Pad Z to LOW			4.2	4.6	5.3	6.2	8.7	ns			
t <sub>ENHZ</sub> Enable Pad HIGH to Z			7.6	8.4	9.5	11.2	15.7	ns			
t <sub>ENLZ</sub> Enable Pad LOW to Z			7.0	7.8	8.8	10.4	14.5	ns			
t <sub>GLH</sub> G-to-Pad HIGH			4.8	5.3	6.0	7.2	10.0	ns			
t <sub>GHL</sub> G-to-Pad LOW			4.8	5.3	6.0	7.2	10.0	ns			
t <sub>LCO</sub> I/O Latch Clock-to-Out (Pad-to-Pad), 64 Clock Loading			8.0	8.9	10.1	11.9	16.7	ns			
t <sub>ACO</sub> Array Clock-to-Out (Pad-to-Pad), 64 Clock Loading			11.3	12.5	14.2	16.7	23.3	ns			
d <sub>TLH</sub> Capacitive Loading, LOW to HIGH			0.04	0.04	0.05	0.06	0.08	ns/pF			
d <sub>THL</sub> Capacitive Loading, HIGH to LOW			0.05	0.05	0.06	0.07	0.10	ns/pF			
<b>CMOS Output Module Timing<sup>5</sup></b>											
t <sub>DLH</sub> Data-to-Pad HIGH			4.5	5.0	5.6	6.6	9.3	ns			
t <sub>DHL</sub> Data-to-Pad LOW			3.4	3.8	4.3	5.1	7.1	ns			
t <sub>ENZH</sub> Enable Pad Z to HIGH			3.8	4.2	4.8	5.6	7.8	ns			
t <sub>ENZL</sub> Enable Pad Z to LOW			4.2	4.6	5.3	6.2	8.7	ns			
t <sub>ENHZ</sub> Enable Pad HIGH to Z			7.6	8.4	9.5	11.2	15.7	ns			
t <sub>ENLZ</sub> Enable Pad LOW to Z			7.0	7.8	8.8	10.4	14.5	ns			
t <sub>GLH</sub> G-to-Pad HIGH			7.1	7.9	8.9	10.5	14.7	ns			
t <sub>GHL</sub> G-to-Pad LOW			7.1	7.9	8.9	10.5	14.7	ns			
t <sub>LCO</sub> I/O Latch Clock-to-Out (Pad-to-Pad), 64 Clock Loading			8.0	8.9	10.1	11.9	16.7	ns			

**Table 42 • A42MX24 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions,  $V_{CCA} = 4.75$  V,  $T_J = 70^\circ\text{C}$ )**

<b>Parameter / Description</b>		<b>-3 Speed</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std Speed</b>		<b>-F Speed</b>	
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>
<b>Input Module Predicted Routing Delays<sup>2</sup></b>											
$t_{IRD1}$	FO = 1 Routing Delay		1.8		2.0		2.3		2.7		3.8 ns
$t_{IRD2}$	FO = 2 Routing Delay		2.1		2.3		2.6		3.1		4.3 ns
$t_{IRD3}$	FO = 3 Routing Delay		2.3		2.5		2.9		3.4		4.8 ns
$t_{IRD4}$	FO = 4 Routing Delay		2.5		2.8		3.2		3.7		5.2 ns
$t_{IRD8}$	FO = 8 Routing Delay		3.4		3.8		4.3		5.1		7.1 ns
<b>Global Clock Network</b>											
$t_{CKH}$	Input LOW to HIGH	FO = 32	2.6		2.9		3.3		3.9		5.4 ns
		FO = 486	2.9		3.2		3.6		4.3		5.9 ns
$t_{CKL}$	Input HIGH to LOW	FO = 32	3.7		4.1		4.6		5.4		7.6 ns
		FO = 486	4.3		4.7		5.4		6.3		8.8 ns
$t_{PWH}$	Minimum Pulse Width HIGH	FO = 32	2.2		2.4		2.7		3.2		4.5 ns
		FO = 486	2.4		2.6		3.0		3.5		4.9 ns
$t_{PWL}$	Minimum Pulse Width LOW	FO = 32	2.2		2.4		2.7		3.2		4.5 ns
		FO = 486	2.4		2.6		3.0		3.5		4.9 ns
$t_{CKSW}$	Maximum Skew	FO = 32	0.5		0.6		0.7		0.8		1.1 ns
		FO = 486	0.5		0.6		0.7		0.8		1.1 ns
$t_{SUEXT}$	Input Latch External Set-Up	FO = 32	0.0		0.0		0.0		0.0		ns
		FO = 486	0.0		0.0		0.0		0.0		ns
$t_{HEXT}$	Input Latch External Hold	FO = 32	2.8		3.1		3.5		4.1		5.7 ns
		FO = 486	3.3		3.7		4.2		4.9		6.9 ns
$t_P$	Minimum Period ( $1/f_{MAX}$ )	FO = 32	4.7		5.2		5.7		6.5		10.9 ns
		FO = 486	5.1		5.7		6.2		7.1		11.9 ns

**Table 43 • A42MX24 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 3.0 V, TJ = 70°C)**

<b>Parameter / Description</b>		<b>-3 Speed</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std Speed</b>		<b>-F Speed</b>	
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>
<b>Logic Module Sequential Timing<sup>3,4</sup></b>											
t <sub>CO</sub>	Flip-Flop Clock-to-Output		2.1		2.0		2.3		2.7		3.7 ns
t <sub>GO</sub>	Latch Gate-to-Output		3.4		1.9		2.1		2.5		3.4 ns
t <sub>SUD</sub>	Flip-Flop (Latch) Set-Up Time	0.4		0.5		0.6		0.7		0.9	ns
t <sub>HD</sub>	Flip-Flop (Latch) Hold Time	0.0		0.0		0.0		0.0		0.0	ns
t <sub>RO</sub>	Flip-Flop (Latch) Reset-to-Output		2.0		2.2		2.5		2.9		4.1 ns
t <sub>SUENA</sub>	Flip-Flop (Latch) Enable Set-Up	0.6		0.6		0.7		0.8		1.2	ns
t <sub>HENA</sub>	Flip-Flop (Latch) Enable Hold	0.0		0.0		0.0		0.0		0.0	ns
t <sub>WCLKA</sub>	Flip-Flop (Latch) Clock Active Pulse Width		4.6		5.2		5.8		6.9		9.6 ns
t <sub>WASYN</sub>	Flip-Flop (Latch) Asynchronous Pulse Width		6.1		6.8		7.7		9.0		12.6 ns
<b>Input Module Propagation Delays</b>											
t <sub>INPY</sub>	Input Data Pad-to-Y		1.4		1.6		1.8		2.2		3.0 ns
t <sub>INGO</sub>	Input Latch Gate-to-Output		1.8		1.9		2.2		2.6		3.6 ns
t <sub>INH</sub>	Input Latch Hold	0.0		0.0		0.0		0.0		0.0	ns
t <sub>INSU</sub>	Input Latch Set-Up	0.7		0.7		0.8		1.0		1.4	ns
t <sub>ILA</sub>	Latch Active Pulse Width		6.5		7.3		8.2		9.7		13.5 ns

**Table 52 • PQ160**

<b>PQ160</b>	<b>Pin Number</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>	<b>A42MX24 Function</b>
	132	I/O	I/O	I/O
	133	I/O	I/O	I/O
	134	I/O	I/O	I/O
	135	NC	VCCA	VCCA
	136	I/O	I/O	I/O
	137	I/O	I/O	I/O
	138	NC	VCCA	VCCA
	139	VCCI	VCCI	VCCI
	140	GND	GND	GND
	141	NC	I/O	I/O
	142	I/O	I/O	I/O
	143	I/O	I/O	I/O
	144	I/O	I/O	I/O
	145	GND	GND	GND
	146	NC	I/O	I/O
	147	I/O	I/O	I/O
	148	I/O	I/O	I/O
	149	I/O	I/O	I/O
	150	NC	VCCA	VCCA
	151	NC	I/O	I/O
	152	NC	I/O	I/O
	153	NC	I/O	I/O
	154	NC	I/O	I/O
	155	GND	GND	GND
	156	I/O	I/O	I/O
	157	I/O	I/O	I/O
	158	I/O	I/O	I/O
	159	MODE	MODE	MODE
	160	GND	GND	GND

**Table 53 • PQ208**

<b>PQ208</b>	<b>Pin Number</b>	<b>A42MX16 Function</b>	<b>A42MX24 Function</b>	<b>A42MX36 Function</b>
	95	NC	I/O	I/O
	96	NC	I/O	I/O
	97	NC	I/O	I/O
	98	VCCI	VCCI	VCCI
	99	I/O	I/O	I/O
	100	I/O	WD, I/O	WD, I/O
	101	I/O	WD, I/O	WD, I/O
	102	I/O	I/O	I/O
	103	SDO, I/O	SDO, TDO, I/O	SDO, TDO, I/O
	104	I/O	I/O	I/O
	105	GND	GND	GND
	106	NC	VCCA	VCCA
	107	I/O	I/O	I/O
	108	I/O	I/O	I/O
	109	I/O	I/O	I/O
	110	I/O	I/O	I/O
	111	I/O	I/O	I/O
	112	NC	I/O	I/O
	113	NC	I/O	I/O
	114	NC	I/O	I/O
	115	NC	I/O	I/O
	116	I/O	I/O	I/O
	117	I/O	I/O	I/O
	118	I/O	I/O	I/O
	119	I/O	I/O	I/O
	120	I/O	I/O	I/O
	121	I/O	I/O	I/O
	122	I/O	I/O	I/O
	123	I/O	I/O	I/O
	124	I/O	I/O	I/O
	125	I/O	I/O	I/O
	126	GND	GND	GND
	127	I/O	I/O	I/O
	128	I/O	TCK, I/O	TCK, I/O
	129	LP	LP	LP
	130	VCCA	VCCA	VCCA
	131	GND	GND	GND

**Table 54 • PQ240**

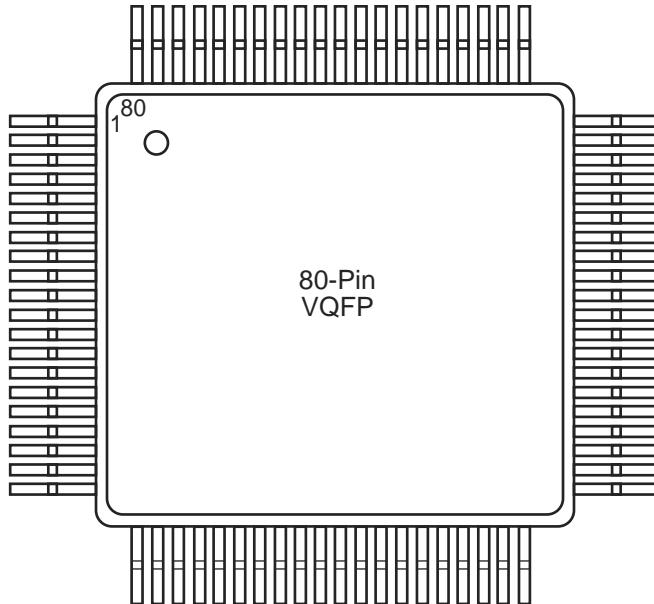
<b>PQ240</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
52	VCCI
53	I/O
54	WD, I/O
55	WD, I/O
56	I/O
57	SDI, I/O
58	I/O
59	VCCA
60	GND
61	GND
62	I/O
63	I/O
64	I/O
65	I/O
66	I/O
67	I/O
68	I/O
69	I/O
70	I/O
71	VCCI
72	I/O
73	I/O
74	I/O
75	I/O
76	I/O
77	I/O
78	I/O
79	I/O
80	I/O
81	I/O
82	I/O
83	I/O
84	I/O
85	VCCA
86	I/O
87	I/O
88	VCCA

**Table 54 • PQ240**

<b>PQ240</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
163	WD, I/O
164	WD, I/O
165	I/O
166	QCLKA, I/O
167	I/O
168	I/O
169	I/O
170	I/O
171	I/O
172	VCCI
173	I/O
174	WD, I/O
175	WD, I/O
176	I/O
177	I/O
178	TDI, I/O
179	TMS, I/O
180	GND
181	VCCA
182	GND
183	I/O
184	I/O
185	I/O
186	I/O
187	I/O
188	I/O
189	I/O
190	I/O
191	I/O
192	VCCI
193	I/O
194	I/O
195	I/O
196	I/O
197	I/O
198	I/O
199	I/O

**Table 54 • PQ240**

<b>PQ240</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
237	GND
238	MODE
239	VCCA
240	GND

**Figure 46 • VQ80****Table 55 • VQ80**

<b>VQ80</b>		
<b>Pin Number</b>	<b>A40MX02 Function</b>	<b>A40MX04 Function</b>
1	I/O	I/O
2	NC	I/O
3	NC	I/O
4	NC	I/O
5	I/O	I/O
6	I/O	I/O
7	GND	GND
8	I/O	I/O
9	I/O	I/O
10	I/O	I/O
11	I/O	I/O
12	I/O	I/O

**Table 55 • VQ80**

<b>VQ80</b>		
<b>Pin Number</b>	<b>A40MX02 Function</b>	<b>A40MX04 Function</b>
49	I/O	I/O
50	CLK, I/O	CLK, I/O
51	I/O	I/O
52	MODE	MODE
53	VCC	VCC
54	NC	I/O
55	NC	I/O
56	NC	I/O
57	SDI, I/O	SDI, I/O
58	DCLK, I/O	DCLK, I/O
59	PRA, I/O	PRA, I/O
60	NC	NC
61	PRB, I/O	PRB, I/O
62	I/O	I/O
63	I/O	I/O
64	I/O	I/O
65	I/O	I/O
66	I/O	I/O
67	I/O	I/O
68	GND	GND
69	I/O	I/O
70	I/O	I/O
71	I/O	I/O
72	I/O	I/O
73	I/O	I/O
74	VCC	<b>VCC</b>
75	I/O	I/O
76	I/O	I/O
77	I/O	I/O
78	I/O	I/O
79	I/O	I/O
80	I/O	I/O

**Table 58 • CQ208**

<b>CQ208</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
1	GND
2	VCCA
3	MODE
4	I/O
5	I/O
6	I/O
7	I/O
8	I/O
9	I/O
10	I/O
11	I/O
12	I/O
13	I/O
14	I/O
15	I/O
16	I/O
17	VCCA
18	I/O
19	I/O
20	I/O
21	I/O
22	GND
23	I/O
24	I/O
25	I/O
26	I/O
27	GND
28	VCCI
29	VCCA
30	I/O
31	I/O
32	VCCA
33	I/O
34	I/O
35	I/O
36	I/O

**Table 59 • CQ256**

<b>CQ256</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
59	I/O
60	VCCA
61	GND
62	GND
63	NC
64	NC
65	NC
66	I/O
67	SDO, TDO, I/O
68	I/O
69	WD, I/O
70	WD, I/O
71	I/O
72	VCCI
73	I/O
74	I/O
75	I/O
76	WD, I/O
77	GND
78	WD, I/O
79	I/O
80	QCLKB, I/O
81	I/O
82	I/O
83	I/O
84	I/O
85	I/O
86	I/O
87	WD, I/O
88	WD, I/O
89	I/O
90	I/O
91	I/O
92	I/O
93	I/O
94	I/O
95	VCCI

**Table 60 • BG272**

<b>BG272</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
J9	GND
J10	GND
J11	GND
J12	GND
J17	VCCA
J18	I/O
J19	I/O
J20	I/O
K1	I/O
K2	I/O
K3	I/O
K4	VCCI
K9	GND
K10	GND
K11	GND
K12	GND
K17	I/O
K18	VCCA
K19	VCCA
K20	LP
L1	I/O
L2	I/O
L3	VCCA
L4	VCCA
L9	GND
L10	GND
L11	GND
L12	GND
L17	VCCI
L18	I/O
L19	I/O
L20	TCK, I/O
M1	I/O
M2	I/O
M3	I/O
M4	VCCI
M9	GND

**Table 60 • BG272**

<b>BG272</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
T19	I/O
T20	I/O
U1	I/O
U2	I/O
U3	I/O
U4	I/O
U5	VCCI
U6	WD, I/O
U7	I/O
U8	I/O
U9	WD, I/O
U10	VCCA
U11	VCCI
U12	I/O
U13	I/O
U14	QCLKB, I/O
U15	I/O
U16	VCCI
U17	I/O
U18	GND
U19	I/O
U20	I/O
V1	I/O
V2	I/O
V3	GND
V4	GND
V5	I/O
V6	I/O
V7	I/O
V8	WD, I/O
V9	I/O
V10	I/O
V11	I/O
V12	I/O
V13	WD, I/O
V14	I/O
V15	WD, I/O

**Table 62 • CQ172**

21	I/O
22	GND
23	VCCI
24	VSV
25	I/O
26	I/O
27	VCC
28	I/O
29	I/O
30	I/O
31	I/O
32	GND
33	I/O
34	I/O
35	I/O
36	I/O
37	GND
38	I/O
39	I/O
40	I/O
41	I/O
42	I/O
43	I/O
44	BININ
45	BINOUT
46	I/O
47	I/O
48	I/O
49	I/O
50	VCCI
51	I/O
52	I/O
53	I/O
54	I/O
55	GND
56	I/O
57	I/O
58	I/O
59	I/O